



PATENT APPLICATION

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IN THE U.S. PATENT AND TRADEMARK OFFICE

September 22, 2003

Applicants : Taketoshi TOYAMA et al
For : ALUMINUM ALLOY FIN MATERIAL FOR HEAT EXCHANGERS
AND HEAT EXCHANGER INCLUDING THE FIN MATERIAL
Serial No. : 10/601 752 Group: 1742
Confirmation No.: 9520
Filed : June 23, 2003 Examiner: Unknown
Atty. Docket No.: Fukuda Case 40
Mail Stop Missing Parts
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

Sir:

This is a response to the Patent Office communication mailed
August 18, 2003, a copy of which is enclosed.

(Please see following pages.)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited
with the United States Postal Service as first class mail in an
envelope addressed to: Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450, on September 22, 2003.

Respectfully submitted,



Terryence F. Chapman

Pursuant to 37 CFR 1.52, 1.53 and/or 1.62, this application was filed without at least one of the filing fee, the English language text and/or the oath or declaration, and was granted the serial number and filing date set forth in the caption of this response. Accordingly, the items listed below are being submitted herewith:

☒ Copy of PTO communication mailed August 18, 2003.

☒ Declaration or Oath

☐ Attached to the Declaration or Oath is a copy of the specification which was filed in the Patent Office in order to obtain a filing date for this application.

☐ Verified English translation of originally-filed foreign language text.

☐ Statement(s) re small entity (37 CFR 1.9 and 1.27):

☐ submitted previously

☐ Statement(s) submitted herewith

☒ A check for \$880.00 to cover fees.

☒ Acknowledgment Postal Card

☒ Priority is claimed under 35 USC 119 based on Japan Application No. 2002-182521, filed June 24, 2002 and Application No. 2003-109792, filed April 15, 2003 .

☐ A certified copy of the priority application is enclosed.

☒ The filing fee is as follows:

☐ Design Application - ☐ \$330.00 (large entity)

☐ \$165.00 (small entity)

☒ Utility Application - as calculated below:

For	No. Filed	No. Extra	(X) LG Entity	RATE	() SM Entity	Fee
Basic Fee				\$750.00	\$375.00	\$750.00
Total Claims	(12 - 20 = 0)		x \$	18.00	x \$	9.00
Indep. Claims	(1 - 3 = 0)		x \$	84.00	x \$	42.00
[] Multiple Dep. Claim			+	\$280.00	+	\$140.00
* * * TOTAL FILING FEE * * *						\$750.00

☒ The surcharge under 37 CFR 1.16(e) for late filing of the basic filing fee and/or the oath or declaration is as follows:

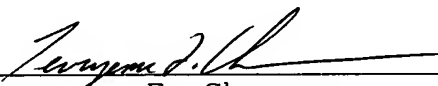
☒ \$130.00 (large entity)

☐ \$ 65.00 (small entity)

- ☐ The fee under 37 CFR 1.17(i) for filing a foreign language text:
- ☐ was submitted previously.
- ☐ is \$130.00 and is included in an enclosed check.
- ☐ Please charge my Deposit Account No. 06-1382 in the amount of \$_____. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 06-1382. A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 CFR 1.16
- ☒ Any patent application processing fees under 37 CFR 1.17
- ☐ The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 06-1382. A duplicate copy of this sheet is enclosed.
- ☐ Any patent application processing fees under 37 CFR 1.17
- ☐ Any filing fees under 37 CFR 1.16 for presentation of extra claims.

Respectfully submitted,

IN DUPLICATE


Terryence F. Chapman

TFC/smd

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Encl: Listed above

115.05/03